

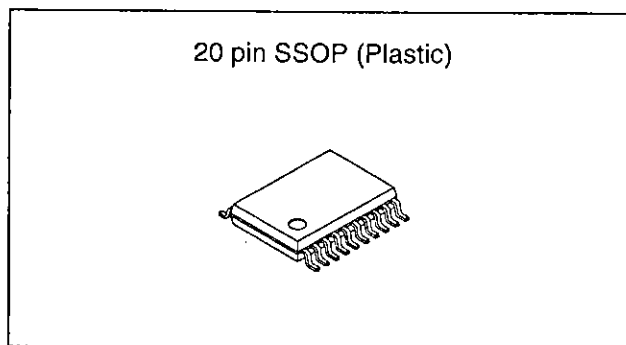
UHF-Band RF Modulator for VCR

Description

The CXA1733N is a UHF-band RF modulator which converts the frequency of audio and video signals. Some circuits which comprise this IC are a UHF oscillator video clamp, white clip, video modulator, audio FM modulator, test pattern signal generator, and an intercarrier SW.

Features

- Low voltage of 5V
- Wide bandwidth 470 to 750MHz
- UHF oscillator greatly reduces external parts
- Sharp white clip circuit
- Built-in voltage regulator can accept large fluctuation of supply voltage
- Video input of 0.5Vp-p for general purpose use
- On-chip mixer simplifies RF unit design
- Picture/sound ratio is adjustable with external parts
- Test pattern signal generator
- Inter carrier switch



Structure

Bipolar silicon monolithic IC

Applications

PAL system VCR

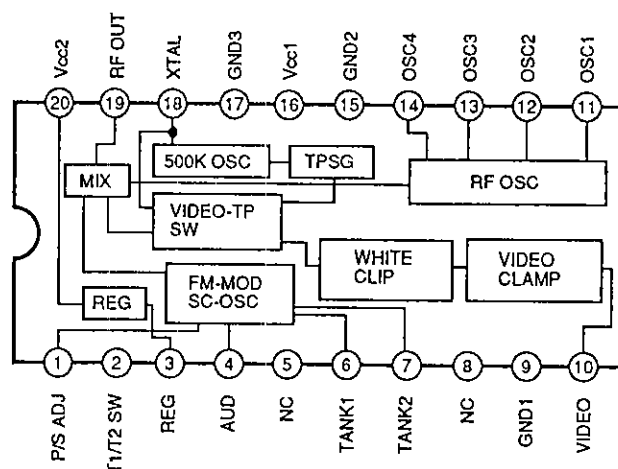
Absolute Maximum Ratings (Ta=25 °C)

• Supply voltage	Vcc	7	V
• Operating temperature	Topr	-20 to +75	°C
• Storage temperature	Tstg	-55 to +150	°C
• Allowable power dissipation	PD	350	mW

Recommended Supply Voltage Range

Supply voltage	Vcc	5.0±0.5	V
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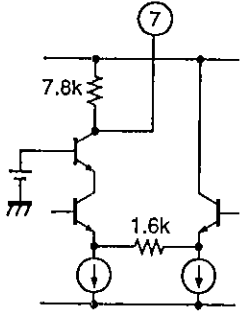
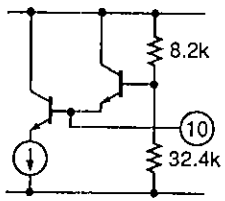
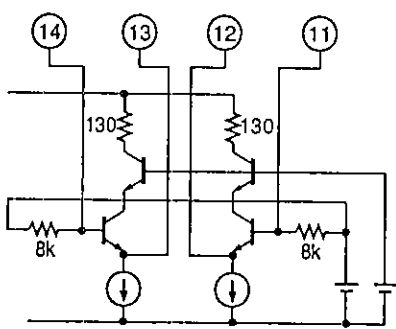
Block Diagram and Pin Configuration



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Pin Description and Equivalent Circuit

Pin No.	Symbol	Pin voltage (V) Typical	Equivalent circuit	Description
1	P/S ADJ	1.8		P/S adjustment (Adding a capacitor between Pin 1 and GND increases P/S ratio.) Video modulation depth adjustment (Adding a resistor between Pin 1 and GND increases the modulation depth; adding a resistor between Pin 1 and 3 decreases the modulation depth.)
2	T1/T2 SW	2.4		T1/T2 SW. T1 for GND. T2 for OPEN.
3	REG OUT	4.1		Regulator output.
4	AUDIO IN	0		Audio input.
5	NC			
6	TANK1	3.1		5.5MHz audio tank coil connection.

Pin No.	Symbol	Pin voltage (V) Typical	Equivalent circuit	Description
7	TANK2	2.9		6.0MHz audio tank coil connection.
8	NC			
9	GND1			GND for audio.
10	VIDEO IN	2.6		Video input.
11 12 13 14	OSC1 OSC2 OSC3 OSC4	2.5 1.7 1.7 2.5		Oscillator pin.
15	GND2			GND for oscillator.
16	Vcc1			Power supply for oscillator.
17	GND3			GND for RF.

Pin No.	Symbol	Pin voltage (V) Typical	Equivalent circuit	Description
18	TPSG SW	1.2		Crystal is connected to this pin. TPSG is OFF for GND.
19	RF OUT	4.1		RF output.
20	VCC2			Power supply for RF/audio.

Electrical Characteristics 1

Refer to Electrical Characteristics Test Circuit (Ta=25°C, Vcc=5V, fP=591.25MHz)

Item	Symbol	Conditions		Min.	Typ.	Max.	Unit
Supply current	Icc	V1(VIDEO IN) and V2(AUDIO IN) at no signal		23	32	40	mA
Video output level	Vo	*1		78.7	81.2	83.7	dB μ V
Video modulation depth	mp	V1=0.5Vp-p, FLAT FIELD signal input		72	78.5	86	%
Max. video modulation depth (During limiter operation)	mp (Max.)	V1=1.0Vp-p, FLAT FIELD signal input		92	95.5	99	%
Chroma beat	Vcb	V1=4.43MHz, 0.5Vp-p sine wave input *5		68	78	—	dB
Sync crush level	Δ Sync	V1=0.5Vp-p, FLAT FIELD signal input Δ Sync= $(1 - \frac{S}{W} \cdot \frac{10}{4}) \times 100$		—	2	5	%
Differential gain	DG	STAIR STEP signal input V1=0.5Vp-p * 2		0	1.6	5	%
Differential phase	DP	STAIR STEP signal input V1=0.5Vp-p * 2		—5	0	5	deg
Video 2nd-harmonic wave ratio	VvH	V1=0.5Vp-p, 1MHz sine wave input*3		48	52.5	—	dB
PS ratio	Vps	V1=no input, fs=5.5MHz		11.5	14	16.5	dB
Audio FM modulation sensitivity	β S1 (T1)	V2=100mVp-p, 1kHz sine wave input fs frequency change/ 0.1V *6	fs=5.5MHz	0.37	0.42	0.475	kHz/mV
	β S2 (T2)		fs=6.0MHz	0.34	0.4	0.47	
Audio distortion	THD	V2=1kHz sine wave input *4		0	0.4	1	%
Audio S/N ratio	ASN	V2=1kHz sine wave input 0dB at fs=5.5MHz with 60kHz deviation V1=STAIR STEP signal input (rms measurement)		45	54	—	dB
Max. audio FM modulation depth	ms (Max.)	V2=1Vp-p, 1kHz sine wave input (T1) fs frequency change (kHz)/ 100 kHz $\times 100$		380	415	—	%
Audio 2nd-harmonic wave ratio	Vs2	Difference between video carrier (V1=no input) and 2nd-harmonic wave, at PS ratio of 14dB conversion		52	57	—	dB
TPSG synchronization period	TMtp	S2 OFF		62	64	66	μ sec
TP video modulation depth	Mtp	S2 OFF		70	80	90	%
Supply current when TPSG is ON	Icc Ton	S2 OFF		24	34	43	mA

Classification of Audio Modulation Sensitivity (T1, fs=5.5MHz)

Marking	Audio modulation sensitivity	Unit
CXA1733N-1	0.4 to 0.445	kHz/mV
CXA1733N-2	0.37 to 0.41	kHz/mV
CXA1733N-3	0.435 to 0.475	kHz/mV

Electrical Characteristics 2

1. Video S/N	50dB (min.), 58dB (typ.)
2. Video amplitude frequency characteristics (at 1MHz reference)	Within ± 1 dB at 0.5 to 5MHz
3. APL variation (Normalized to APL 50%)	Within $\pm 2\%$ at 10 to 90%
4. Pin 4 input impedance	1M Ω and above
5. Pin 10 input impedance	1M Ω and above

*1. Spectrum analyzer with 50 Ω input impedance should be used to test video output level. Measured value V_o (dBm) is used to calculate output according to following relationship:

$$\text{Output (dB } \mu\text{)} = V_o \text{ (dBm)} + 107 \quad 50 \Omega \text{ terminal direct reading value}$$

*2. Measured after demodulating by standard demodulator.

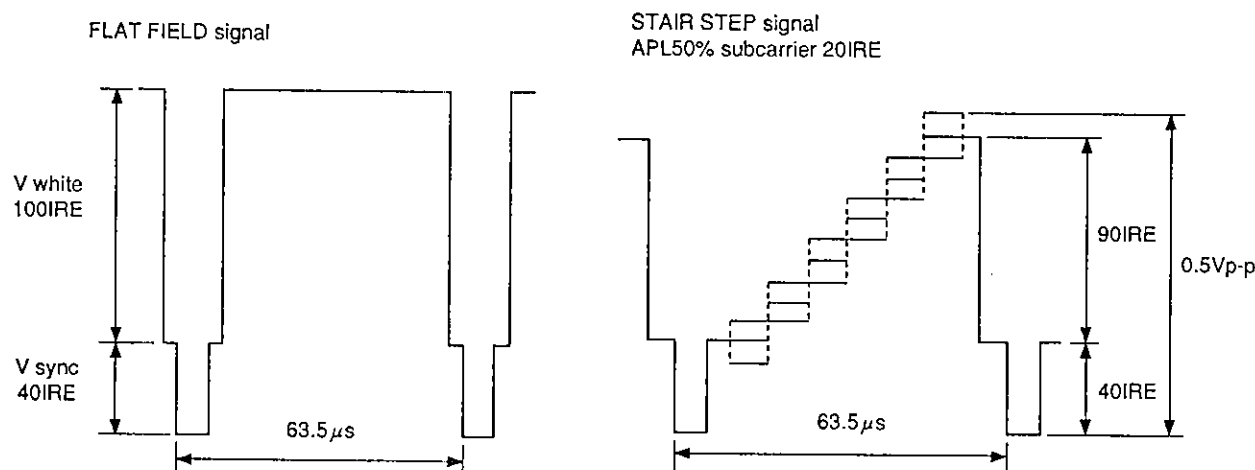
*3. $f_c + 2\text{MHz}$ component of V_1 carrier (f_c) level.

*4. Adjust the V_2 level to obtain an FM deviation of $\pm 30\text{kHz}$ and measure the harmonic distortion after demodulating V_o with a standard demodulator.

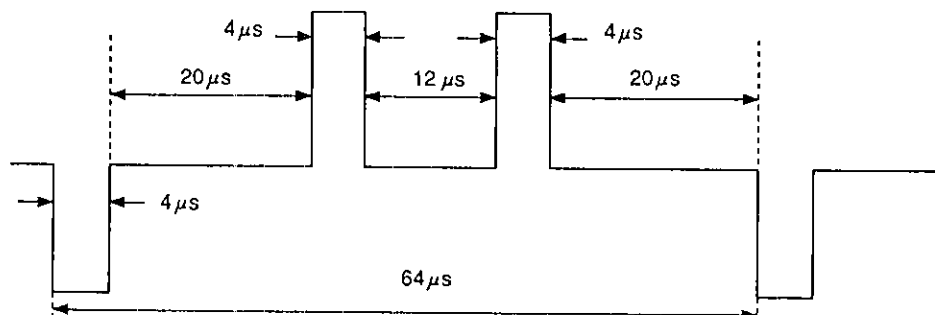
*5. Value determined by measuring ratio (dB) of chroma beat to video carrier level when $V_1 = \text{no signal}$ by spectrum analyzer.

*6. R_1 (12k Ω) of the Electrical Characteristics Test Circuit is added for obtaining a better match between the audio modulation sensitivity classifications and the actual pre-emphasis.

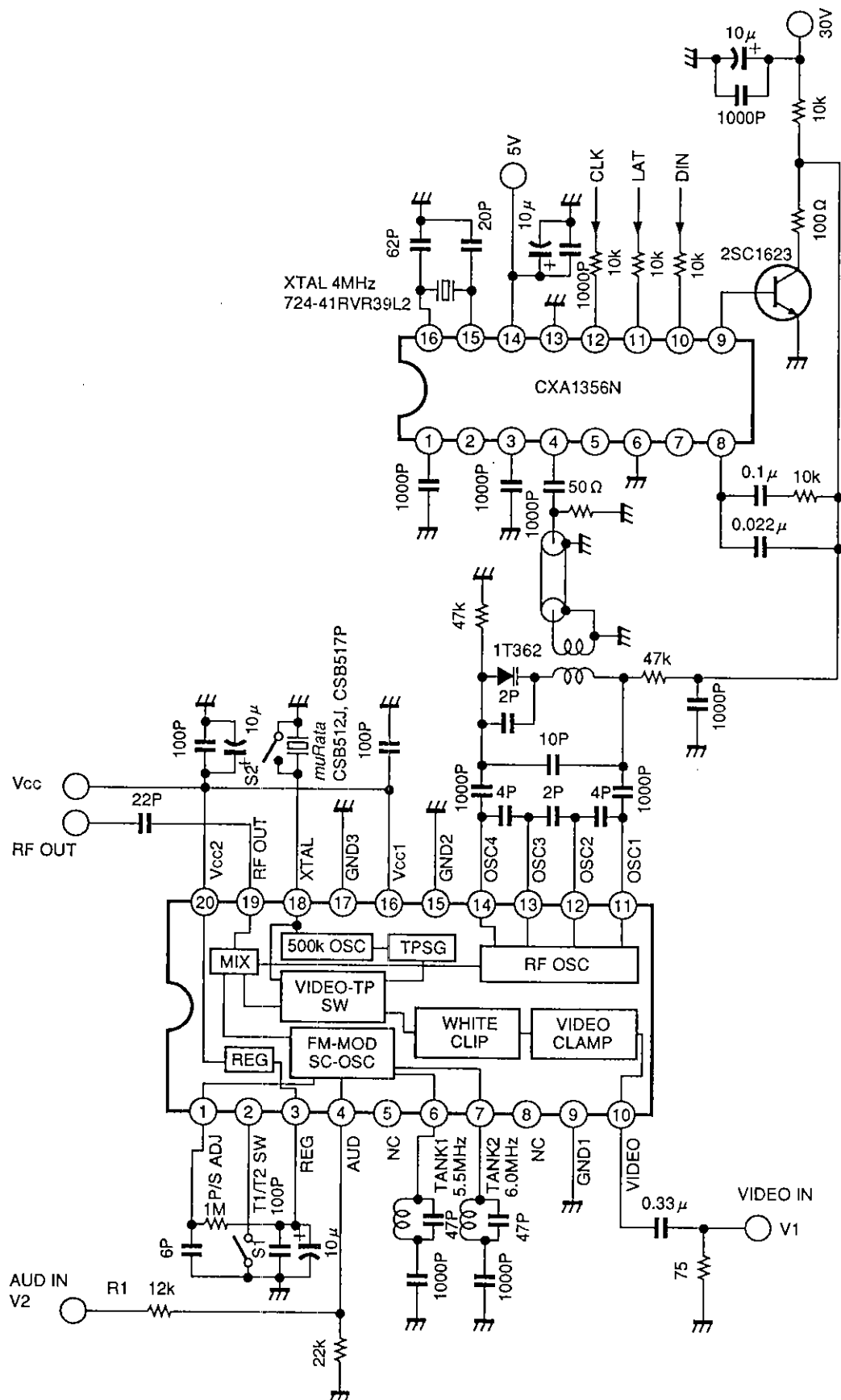
Input Waveform



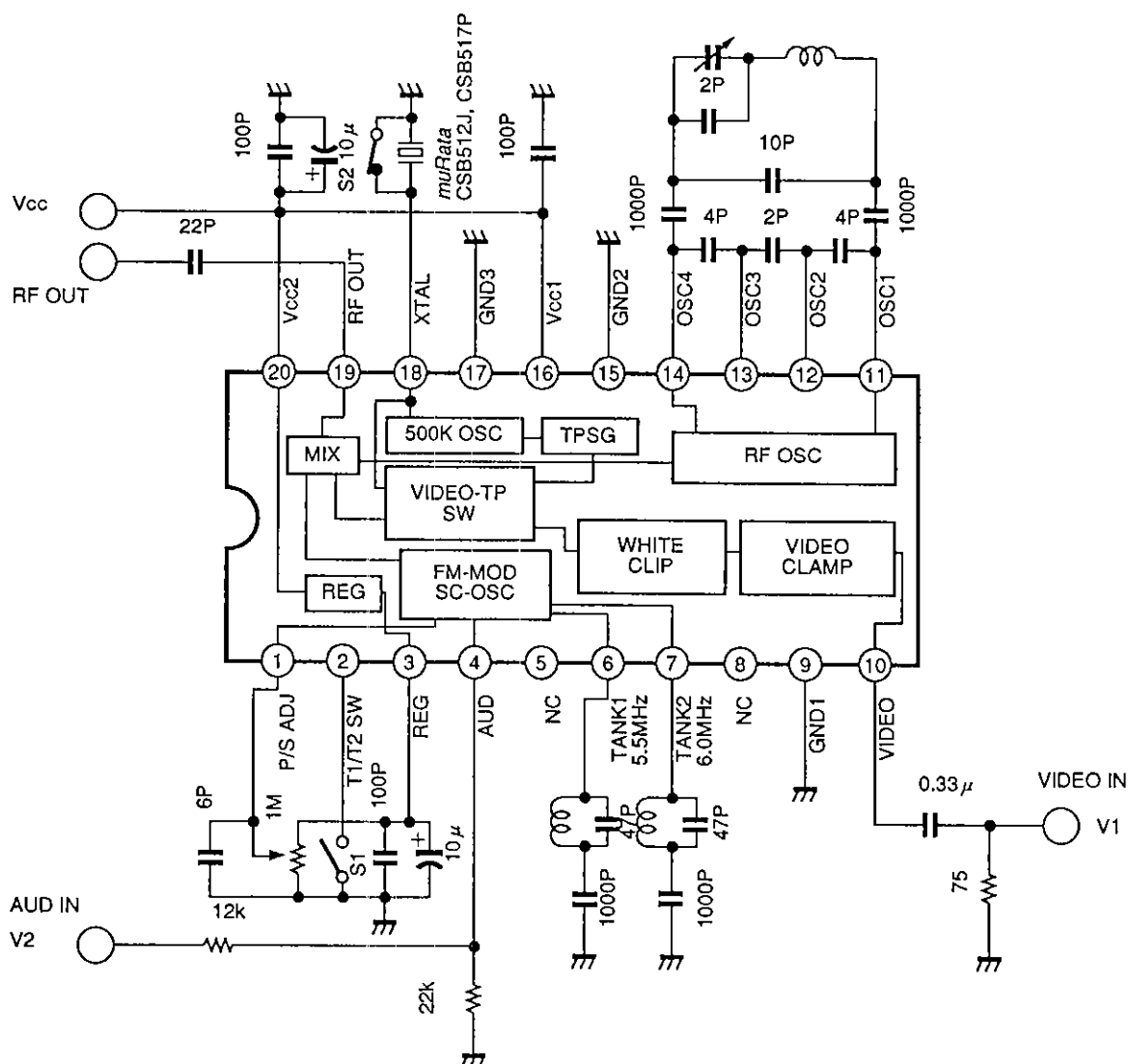
TPSG Waveform



Electrical Characteristics Test Circuit



Application Circuit 1



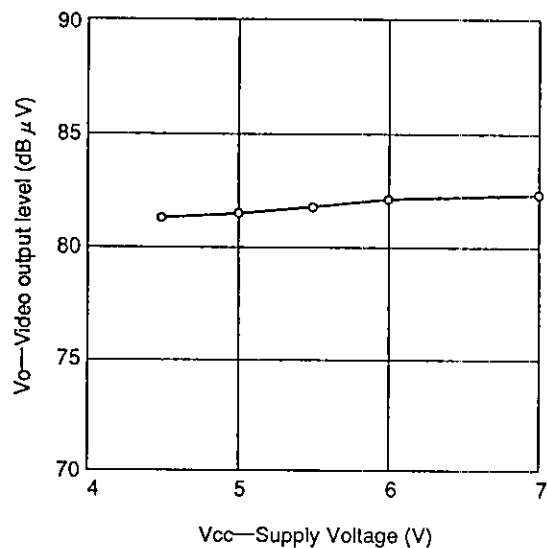
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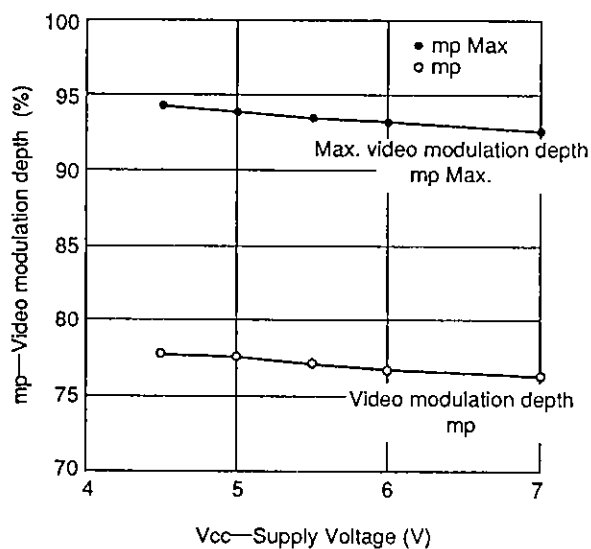
Example of Representative Characteristics

(fp=591.25MHz, Ta=25°C)

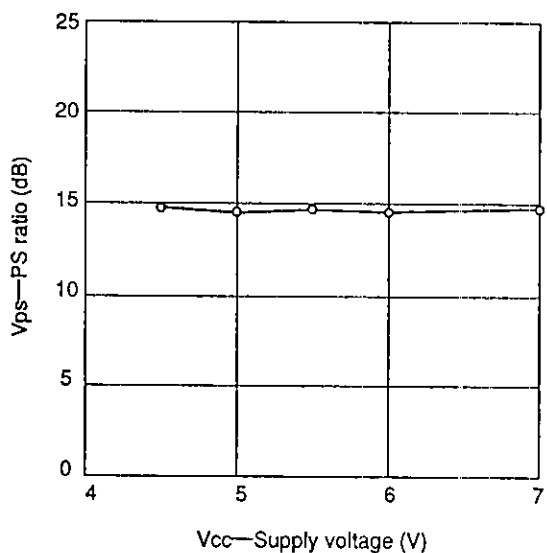
Supply voltage vs. Video output level



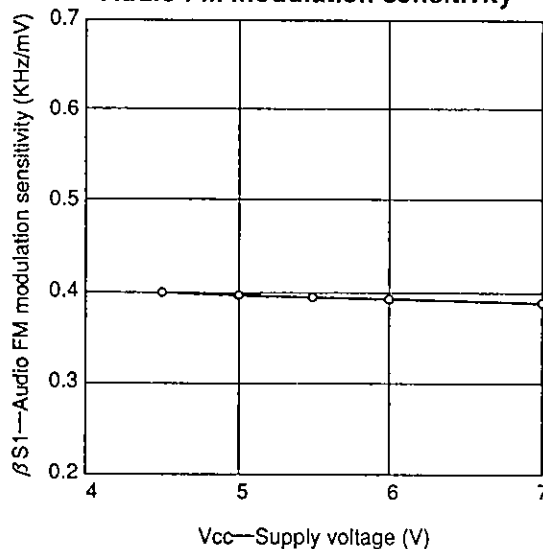
Supply voltage vs. Video modulation depth



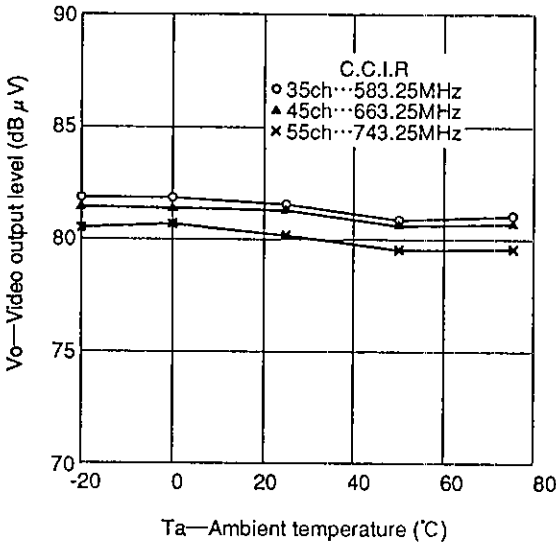
Supply voltage vs. PS ratio



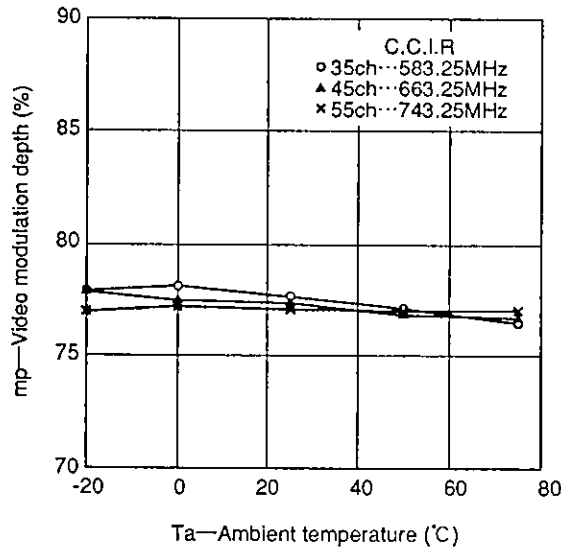
Supply voltage vs. Audio FM modulation sensitivity



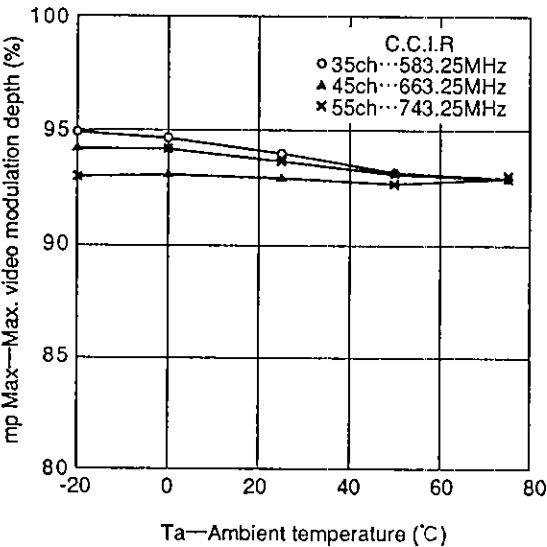
Ambient temperature vs. Video output level



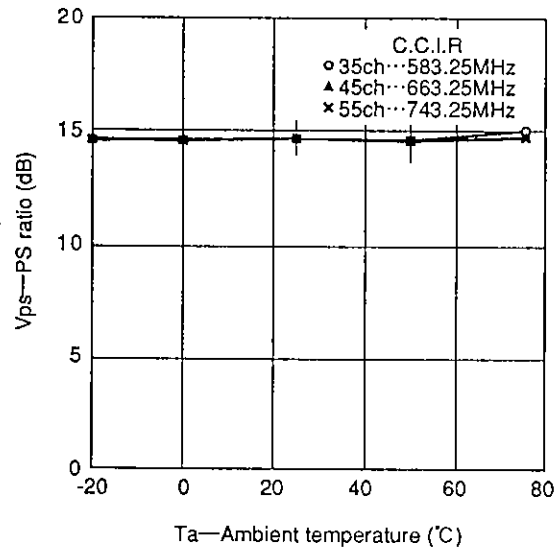
Ambient temperature vs. Video modulation depth



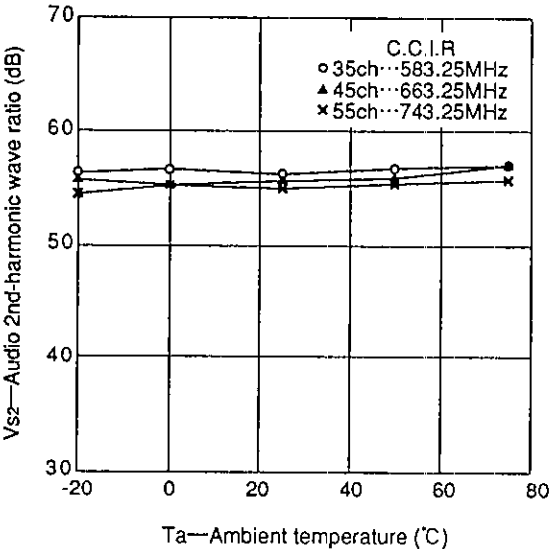
Ambient temperature vs. Max. video modulation depth



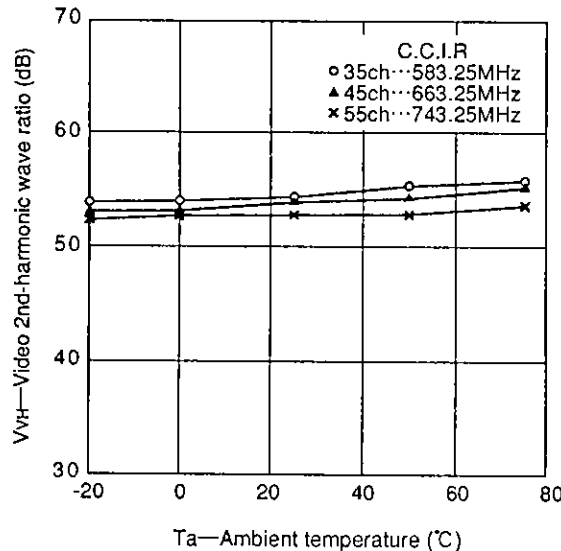
Ambient temperature vs. PS ratio



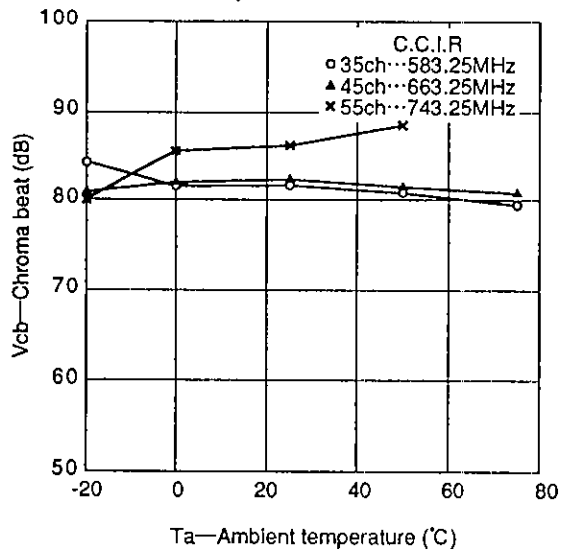
Ambient temperature vs. Audio 2nd-harmonic wave ratio



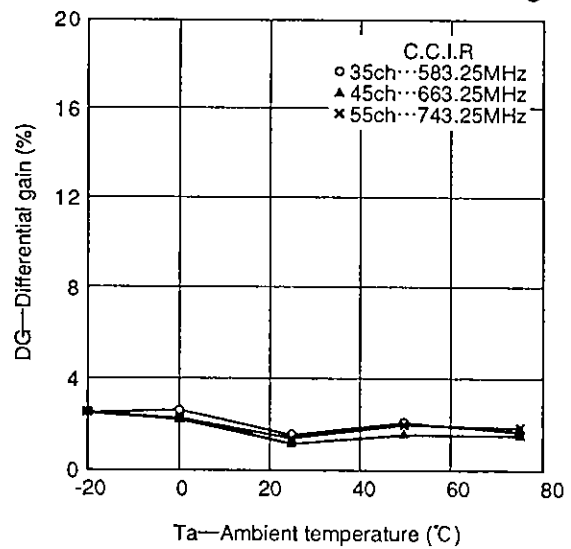
Ambient temperature vs. Video 2nd-harmonic wave ratio



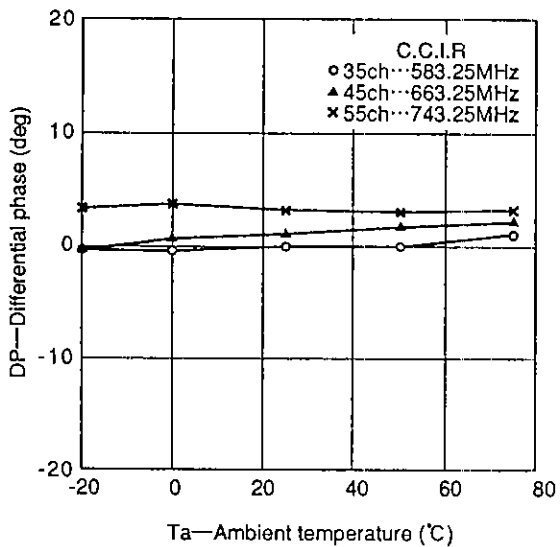
Ambient temperature vs. Chroma beat



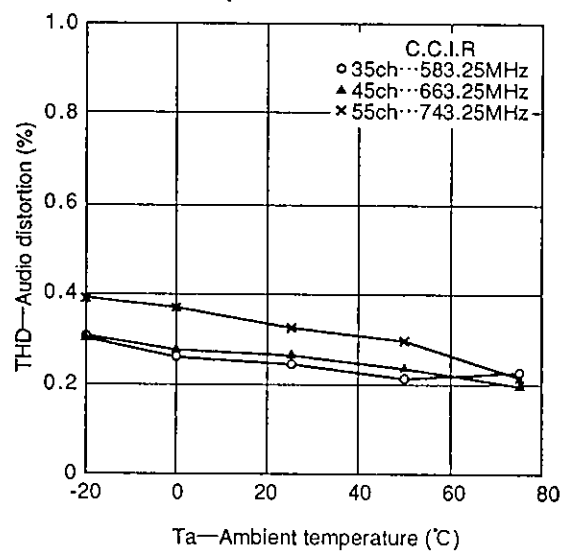
Ambient temperature vs. Differential gain



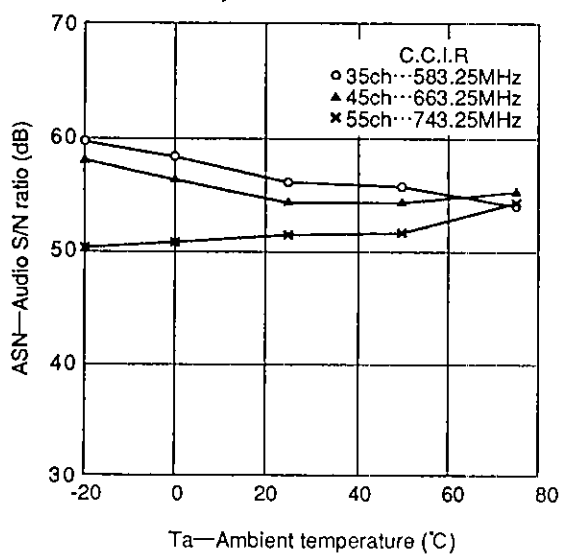
Ambient temperature vs. Differential phase



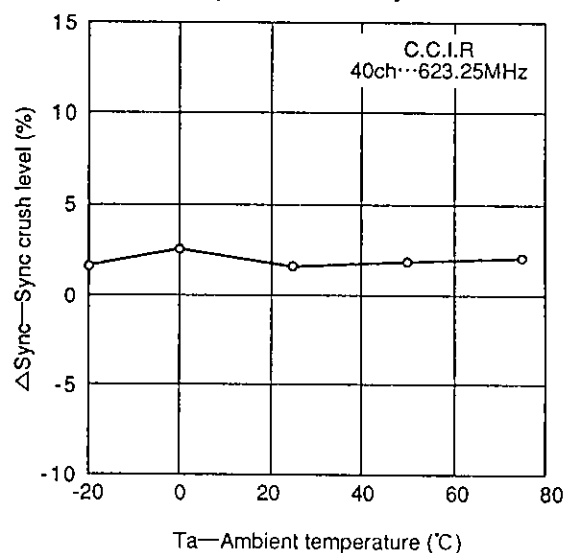
Ambient temperature vs. Audio distortion



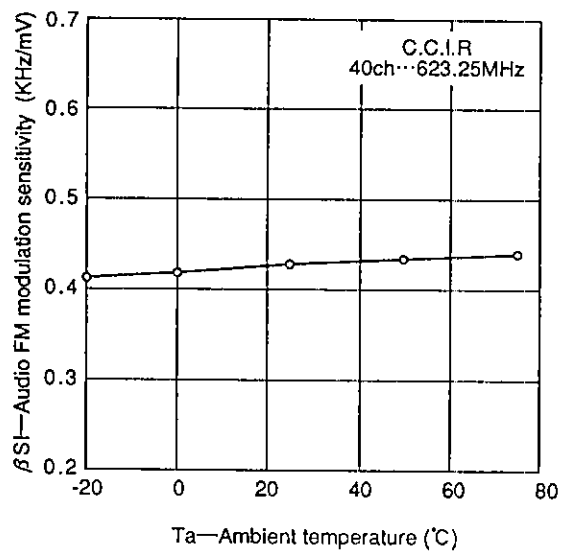
Ambient temperature vs. Audio S/N ratio



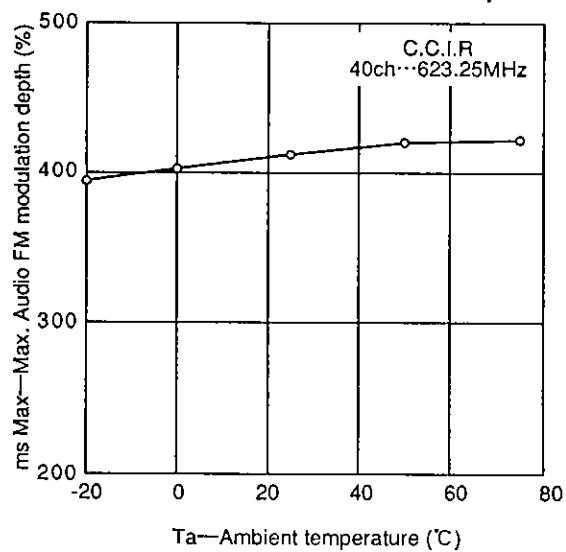
Ambient temperature vs. Sync crush level



Ambient temperature vs.
Audio FM modulation sensitivity



Ambient temperature vs.
Max. audio FM modulation depth

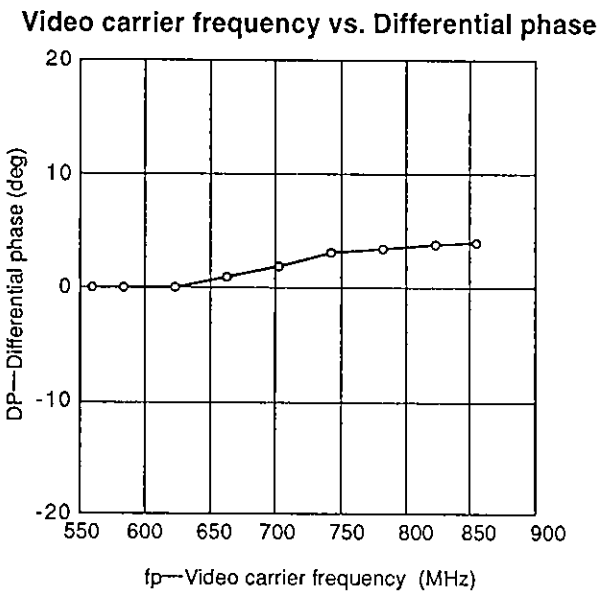
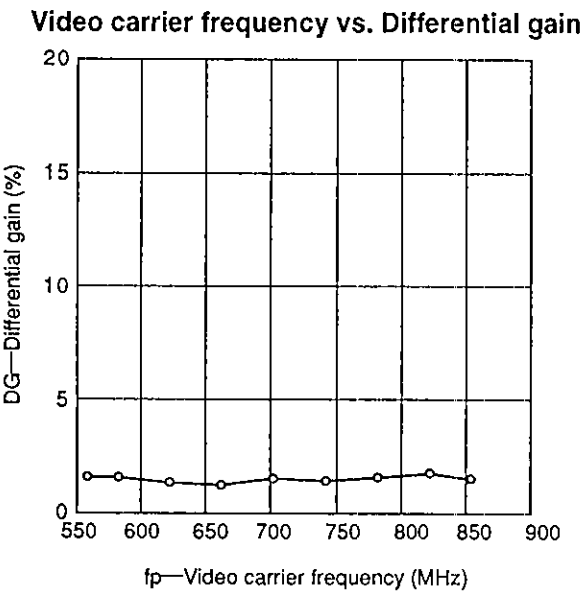
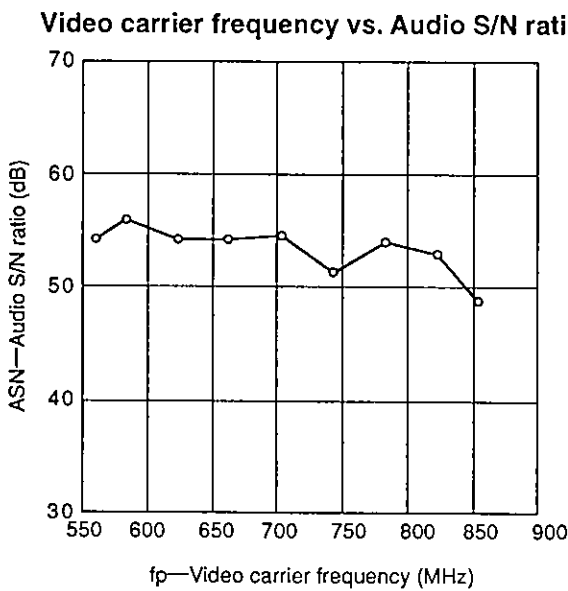
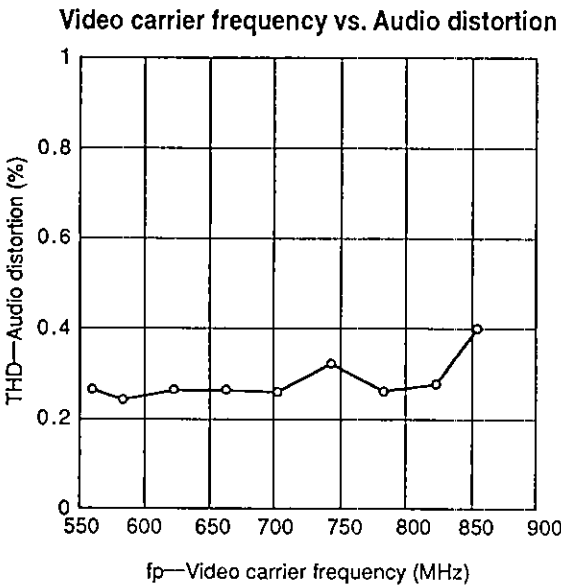


Video carrier frequency vs. Video output level



Video carrier frequency vs. Video modulation depth

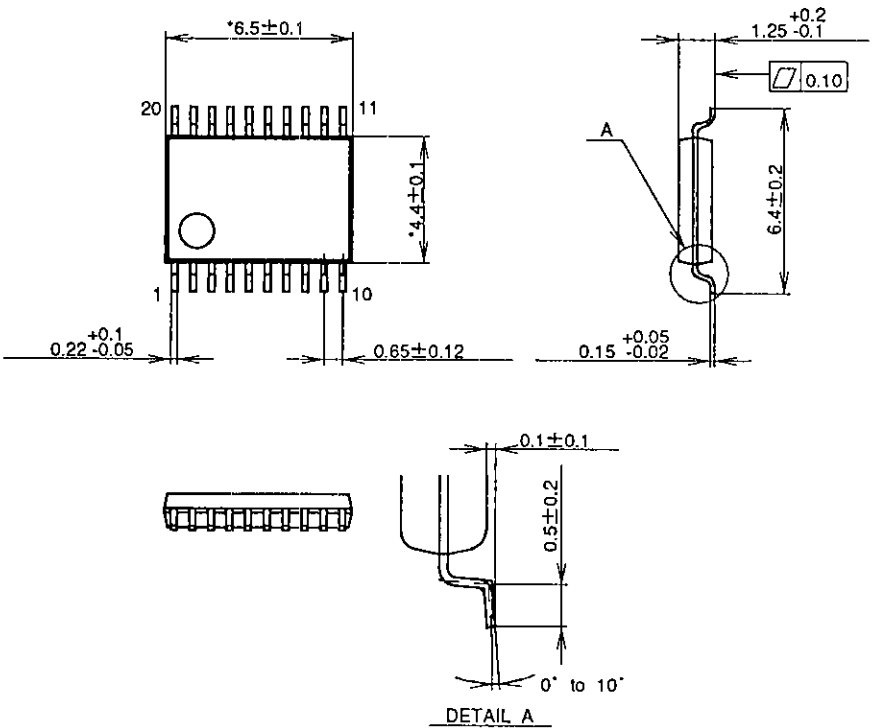




Package Outline

Unit: mm

20PIN SSOP(PLASTIC) 225MIL



NOTE: *NOT INCLUDE MOLD FINIS.

PACKAGE STRUCTURE

SONY CODE	SSOP-20P-L01	PACKAGE MATERIAL	EPOXY RESIN
EIAJ CODE	A SIMILAR to SSOP020-P-0225	LEAD TREATMENT	SOLDER PLATING
JEDEC CODE		LEAD MATERIAL	42 ALLOY
		PACKAGE WEIGHT	0.1g